MOSFET – Power, **N-Channel, Logic Level** 100 V, 25 A, 50 mΩ

NVD6495NL

Features

- Low R_{DS(on)}
- 100% Avalanche Tested
- AEC-Q101 Qualified
- These Devices are Pb-Free and are RoHS Compliant

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Parameter			Symbol	Value	Unit	
Drain-to-Source Voltage			V _{DSS}	100	V	
Gate-to-Source Voltag	ge – Conti	nuous	V _{GS}	±20	V	
Continuous Drain	Steady	$T_{C} = 25^{\circ}C$	Ι _D	25	А	
Current	State	$T_{C} = 100^{\circ}C$	l	18		
Power Dissipation	Steady T _C = 25°C State		P _D 83		W	
Pulsed Drain Current	tp	= 10 μs	I _{DM}	80	А	
Operating and Storage Temperature Range			T _J , T _{stg}	-55 to +175	°C	
Source Current (Body Diode)			Is	25	A	
Single Pulse Drain-to-Source Avalanche Energy (V _{DD} = 50 Vdc, V _{GS} = 10 Vdc, I _{L(pk)} = 23 A, L = 0.3 mH, R _G = 25 Ω)			EAS	079 N	mU	
Lead Temperature for Soldering Purposes, 1/8" from Case for 10 Seconds			, I'C	260	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE RATINGS

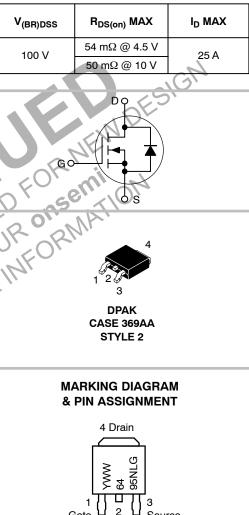
Parameter	Symbol	Max	Unit
Junction-to-Case (Drain) - Steady State	$R_{\theta JC}$	1.8	°C/W
Junction-to-Ambient - Steady State (Note 1)	$R_{\theta JA}$	49	

1. Surface mounted on FR4 board using 1 sq in pad size, (Cu Area 1.127 sq in [2 oz] including traces).



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Gate	Drain	Source

6495NL	= Device Code
Y	= Year
WW	= Work Week
G	= Pb-Free Packag

= Pb-Free Package

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise noted)

Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS	•				I		<u> </u>
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	$\label{eq:VGS} \begin{array}{l} V_{GS} = 0 \; V, \; I_D = 250 \; \mu A \\ V_{GS} = 0 \; V, \; I_D = 250 \; \mu A, \; T_J = -40^\circ C \end{array}$		100 92			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	$V_{(BR)DSS}/T_J$				115		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V, V _{DS} = 100 V	T _J = 25°C T _J = 125°C			1.0 100	μΑ
Gate-to-Source Leakage Current	I _{GSS}	V _{DS} = 0 V, V _{GS} =	±20 V			±100	nA
ON CHARACTERISTICS (Note 2)							
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_D = 2$	250 μΑ	1.0		2.0	V
Negative Threshold Temperature Coefficient	V _{GS(TH)} /T _J				4.8		mV/°C
Drain-to-Source On-Resistance	R _{DS(on)}	V _{GS} = 4.5 V, I _D =	= 10 A		44	54	mΩ
		V_{GS} = 10 V, I _D =	V _{GS} = 10 V, I _D = 10 A		43	50	
Forward Transconductance	9 FS	V _{DS} = 5.0 V, I _D = 10 A			24	2	S
CHARGES, CAPACITANCES AND GAT	E RESISTANC	CE			NV		
Input Capacitance	C _{ISS}				1024		pF
Output Capacitance	C _{OSS}	V_{GS} = 0 V, f = 1.0 MHz, V_{DS} = 25 V		2	156		
Reverse Transfer Capacitance	C _{RSS}), '(70		
Total Gate Charge	Q _{G(TOT)}		20)	Ser	20		nC
Threshold Gate Charge	Q _{G(TH)}			N. NP	1.1		
Gate-to-Source Charge	Q _{GS}	V _{GS} = 4.5 V, V _{DS} = 80	v, I _D = 23 A	R12	3.1		
Gate-to-Drain Charge	Q _{GD}	MNIL	0 F	<u> </u>	14		
Total Gate Charge	Q _{G(TOT)}	$V_{GS} = 10 \text{ V}, \text{ V}_{DS} = 80 \text{ V}, \text{ I}_{D} = 23 \text{ A}$			35		nC
SWITCHING CHARACTERISTICS (Not	e 3)	SE AP 20	36				
Turn-On Delay Time	t _{d(on)}	ON ET			11		ns
Rise Time		V_{GS} = 4.5 V, V_{DD} = 80 V, I_D = 23 A, R_G = 6.1 Ω			91		
Turn-Off Delay Time	t _{d(off)}				40		
Fall Time	< ∀ <				71		
DRAIN-SOURCE DIODE CHARACTER	RISTICS						
Forward Diode Voltage	VSD	V_{GS} = 0 V, I _S = 23 A	$T_{\rm J} = 25^{\circ}{\rm C}$ $T_{\rm J} = 125^{\circ}{\rm C}$		0.87 0.74	1.2	V
Reverse Recovery Time	t _{RR}		J J		64		ns
Charge Time	T _a	V_{GS} = 0 V, dI _S /dt = 100 A/µs, I _S = 23 A			40		
Discharge Time	Γ _a				24		
Reverse Recovery Charge	Q _{RR}				152		nC
nevere needed y ondige	SKK				102		

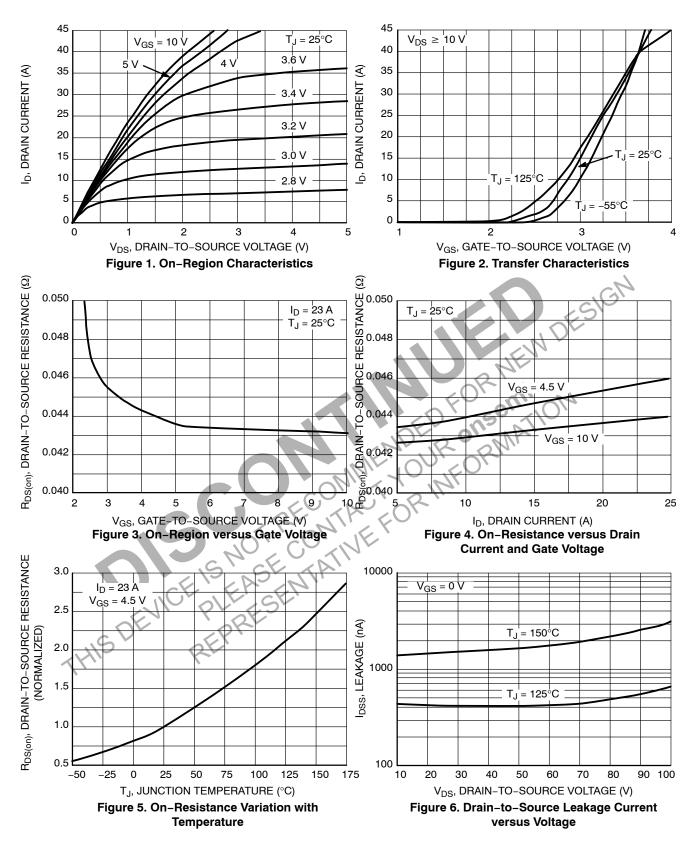
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 2. Pulse Test: Pulse Width \leq 300 µs, Duty Cycle \leq 2%.

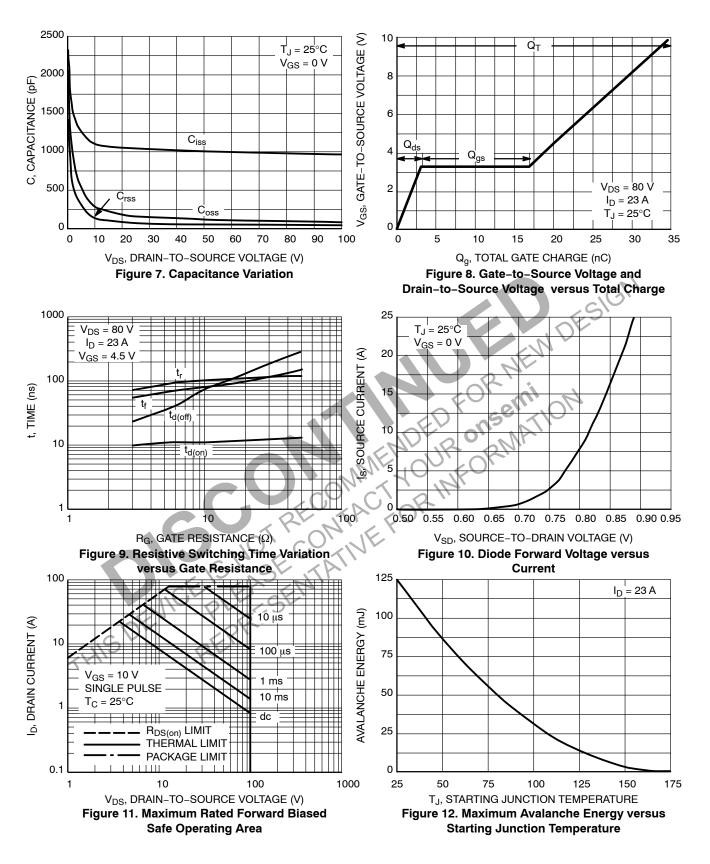
3. Switching characteristics are independent of operating junction temperatures.

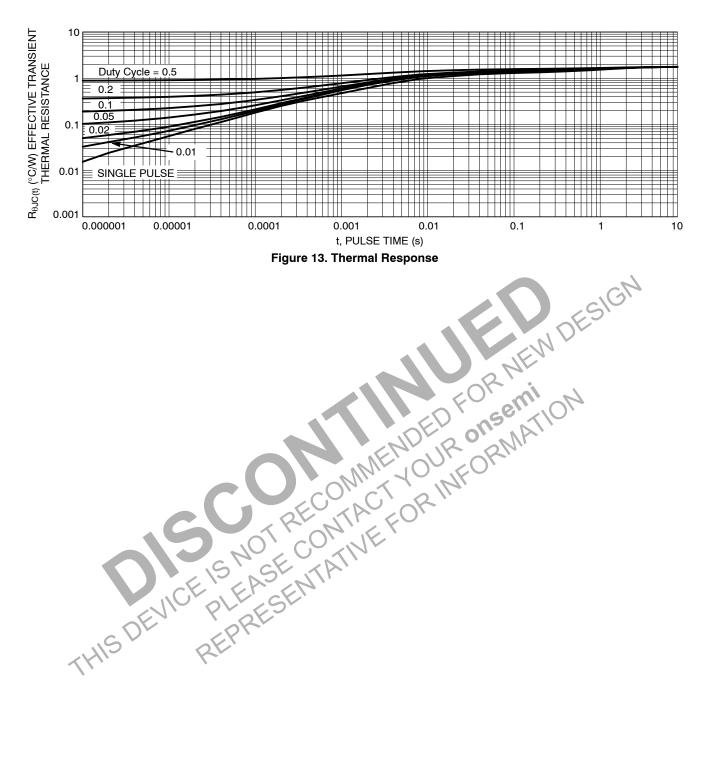
ORDERING INFORMATION

Device	Package	Shipping [†]
NVD6495NLT4G	DPAK (Pb-Free)	2500 / Tape & Reel

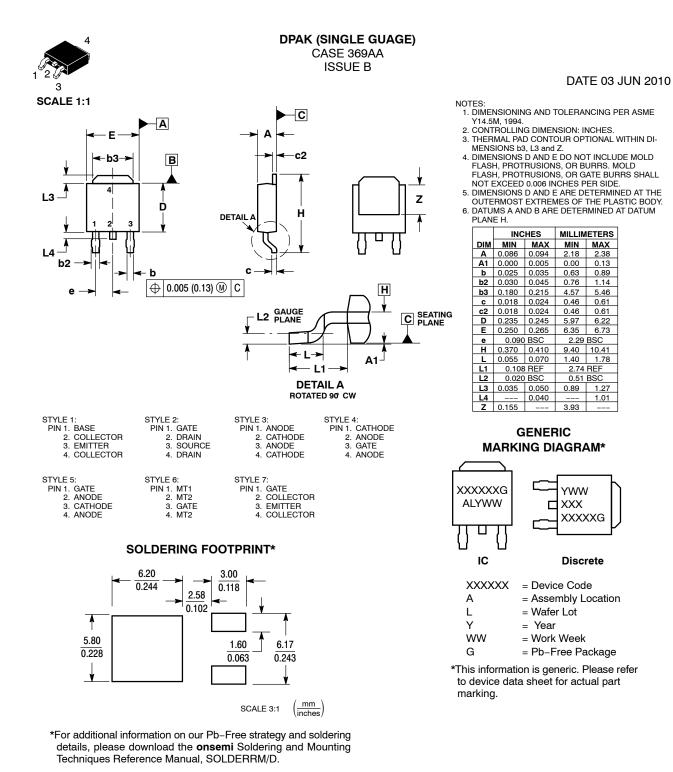
+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.







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